NOTES:
1. MATERIAL
1.1 HOUSING : HIGH TEMPERATURE THERMOPLASTIC UL94V-0. COLOR: BLACK.
1.2 CONTACT: COPPER ALLOY.
1.3 SOLDER PEG: STAINLESS STEEL

2. FINISH
2.1 CONTACT: UNDERCOAT NICKEL 50u" min.
ALL OVER:
MATING AREA: GOLD PLATING. THE THICKNESS
SEE TABLE LIST;
SOLDERABLE AREA: GOLDFLASH.

2.2 SOLDER PEG: UNDERCOAT: NICKEL 50u" min.
ALL OVER
SOLDERABLE AREA: MATTE TIN 100u" min.

3. COPLANARITY: 0.10mm MAX.(BEFORE SOLDERING).

4. ACCEPTED MODULE BASED ON INDUSTRY STD.

5. KEY ID, "*" IS A CAPTICAL LETTER PER THE PART NO.

6. THE PIN NO. DEFINITIONS ARE ACCORDING TO PCB FOOTPRINT. THE ACTUAL PIN QUANTITY IS ONLY 67 POS. FOR KEY TAKING OUT 8 POS.

7. THE PRODUCT IS ROHS COMPLIANT.
BR 900PPM MAX., CL 900PPM MAX.
BR4&CL 1500 PPM MAX.

8. MINUS MEANS 1" OF KEY IS ON THE RIGHT SIDE OF CONN. IN PAGE 1.
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**KEY**
- **D** PRODUCT SPEC
- **G** GOLD SPEC
- **G** DIM. C
- **G** DIM. E
- **G** DIM. D
- **G** DIM. C
- **G** DIM. B
- **G** DIM. A
- **G** PART NO.

**NOTE**
- This drawing is a controlled document.

**TE Connectivity**

M.2(NGFF) MINI CARD MOUNTING TYPE
0.50mm PITCH 67 POS. 3.2mm HEIGHT
FOR DOUBLE SIDED MODULE

**MATERIAL**
- -

**REMARKS**
- -

**CUSTOMER DRAWING**
- A300779 C=2199119

**SCALE**
- 4:1

**SHEET**
- 2 of 4

**PD C**
NOTES: (APPLIED TO CURRENT SHEET)

1. THE DIRECTION OF EACH CONNECTOR ON A EMBOSST/IS REFERRED TO THIS DRAWING.

2. GENERAL TOLERANCE: ±0.5, ±3°

3. PACKAGED IN EMBOSST TAPE AND PLASTIC REEL 1200PCS PER REEL.